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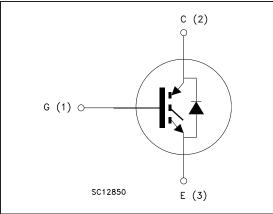


STGW35NC120HD

32 A, 1200 V very fast IGBT

TO-247 long leads

Figure 1. Internal schematic diagram



Datasheet - production data

Features

- Low on-losses
- Low on-voltage drop (V_{CE(sat)})
- High current capability
- IGBT co-packaged with ultrafast free-wheeling diode
- Low gate charge
- Ideal for soft switching application

Application

- Induction heating
- High frequency inverters
- UPS

Description

This IGBT utilizes the advanced PowerMESH[™] process resulting in an excellent trade-off between switching performance and low on-state behavior.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW35NC120HD	GW35NC120HD	TO-247 long leads	Tube

DocID14378 Rev 3

This is information on a product in full production.

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1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	1200	V
I _C ⁽¹⁾	Continuous collector current at $T_C = 25 \ ^{\circ}C$	60	А
I _C ⁽¹⁾	Continuous collector current at $T_C = 100 \ ^{\circ}C$	32	А
I _{CL} ⁽²⁾	Turn-off latching current	135	А
I _{CP} ⁽³⁾	Pulsed collector current	135	А
V _{GE}	Gate-emitter voltage	±25	V
P _{TOT}	Total dissipation at T_{C} = 25 °C	235	W
١ _F	Diode RMS forward current at $T_C = 25 \text{ °C}$	30	А
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal	100	А
Тj	Operating junction temperature	–55 to 150	°C

Table 2	2. Absolute	maximum	ratings
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1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

2. Vclamp = 80% of V_{CES}, T_j =125 °C, R_G=10 Ω , V_GE=15 V

3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal data

Symbol Parameter		Value	Unit
Thermal resistance junction-case IGBT		0.53	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb} Thermal resistance junction-ambient		50	°C/W



2 Electrical characteristics

(T_i =25 °C unless otherwise specified)

Table 4. Static						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	1200			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A, V _{GE} = 15 V, I _C = 20 A, T _j =125 °C		2.2 2.0	2.75	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current $(V_{GE} = 0)$	V _{CE} =1200 V V _{CE} =1200 V, T _j =125 °C			500 10	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20 V			± 100	nA
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{CE} = 25 V_{,} I_{C} = 20 A$		14		S

1. Pulse duration = 300 μ s, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies}	Input capacitance		-	2510	-	pF
C _{oes}	Output capacitance	V _{CF} = 25 V, f = 1 MHz, V _{GF} =0	-	175	-	pF
C _{res}	Reverse transfer capacitance	₩ <u>₩</u>		30	-	pF
Qg	Total gate charge			110	-	nC
Q _{ge}	Gate-emitter charge	V _{CE} = 960 V, I _C = 20 A,V _{GE} =15 V	-	16	-	nC
Q _{gc}	Gate-collector charge		-	49	-	nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{CC} = 960 V, I _C = 20 A	-	29	-	ns
t _r	Current rise time	R _G = 10 Ω, V _{GE} = 15 V,	-	11	-	ns
(di/dt)on	Turn-on current slope	Figure 17	-	1820	-	A/μs
t _{d(on)}	Turn-on delay time	V _{CC} = 960 V, I _C = 20 A	-	27	-	ns
t _r	Current rise time	R_{G} = 10 Ω, V_{GE} = 15 V,	-	14	-	ns
(di/dt)on	Turn-on current slope	T _j =125 °C <i>Figure 17</i>	-	1580	-	A/μs
t _{r(Voff)}	Off voltage rise time	V _{CC} = 960 V, I _C = 20 A	-	90	-	ns
t _{d(off)}	Turn-off delay time	R _G = 10 Ω, V _{GE} = 15 V,	-	275	-	ns
t _f	Current fall time	Figure 17	-	312	-	ns
t _{r(Voff)}	Off voltage rise time	V _{CC} = 960 V, I _C = 20 A	-	150	-	ns
t _{d(off)}	Turn-off delay time	R _G = 10 Ω, V _{GE} = 15 V,	-	336	-	ns
t _f	Current fall time	T _j =125 °C <i>Figure 17</i>	-	592	-	ns

Table 6. Switching on/off (inductive load)

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon ⁽¹⁾	Turn-on switching losses	V _{CC} = 960 V, I _C = 20 A	-	1660	-	μJ
E _{off} ⁽²⁾	Turn-off switching losses	R _G = 10 Ω, V _{GE} = 15 V,		4438		μJ
E _{ts}	Total switching losses	Figure 17		6098		μJ
Eon ⁽¹⁾	Turn-on switching losses	V _{CC} = 960 V, I _C = 20 A	-	3015	-	μJ
E _{off} ⁽²⁾	Turn-off switching losses	R _G = 10 Ω, V _{GE} = 15 V,	-	6900	-	μJ
E _{ts}	Total switching losses	T _j =125 °C <i>Figure 17</i>	-	9915	-	μJ

 Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

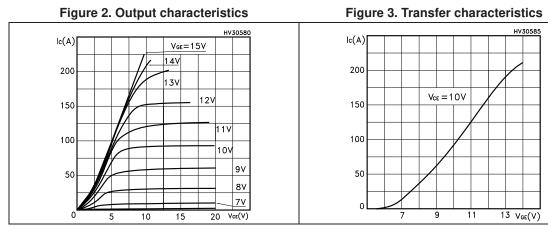
2. Turn-off losses include also the tail of the collector current

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
VF	Forward on-voltage	I _F = 20 A		1.9	2.5	V
۷F	Forward on-voltage	I _F = 20 A, T _C = 125 °C	-	1.7		V
t _{rr}	Reverse recovery time	I _F = 20 A, V _B = 27 V,	-	152	-	ns
Q _{rr}	Reverse recovery charge	$T_j = 125 \text{ °C}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	722	-	nC
I _{rrm}	Reverse recovery current	Figure 20	-	9	-	А



2.1 Electrical characteristics (curves)





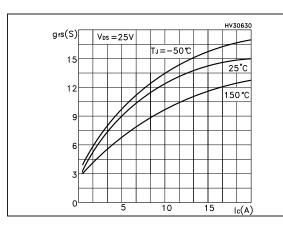


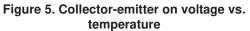
Figure 6. Gate charge vs. gate-source voltage

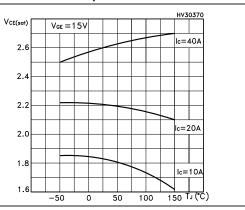
60 80

20 40

HV30410

100 120Qg(nC)





e Figure 7. Capacitance variations C(pF) 4000 3000 2000 1000 C_{res} C_{res}

20 30 40 VCE(V)

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VGE(V)

15

12

9

6

0

Vcc=780V lc=20A

Figure 8. Normalized gate threshold voltage vs. temperature

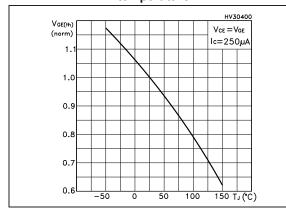


Figure 10. Normalized breakdown voltage vs. temperature

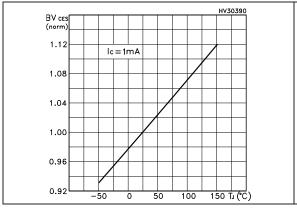


Figure 9. Collector-emitter on voltage vs. collector current

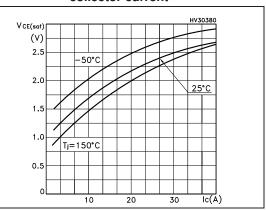


Figure 11. Switching losses vs. temperature

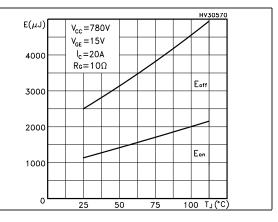


Figure 12. Switching losses vs. gate resistance Figure 13. Switching losses vs. collector current

HV30600	HV30590
E(µJ) V _{cc} =780V	E(µJ) V _{cc} =780V
$\begin{array}{c c} & V_{oc} = 15V \\ & I_{c} = 20A \\ & T_{J} = 125^{\circ}C \end{array} \end{array} \begin{array}{c c} E_{off} \\ \hline \end{array}$	Vor = 15V Eoff 8000 TJ=125°C Eoff
6000	6000
4000 Eon	4000 Eon
2000	2000
0 50 100 150 200 R _G (Ω)	0 10 20 30 40 I _C (A)



Figure 14. Thermal Impedance

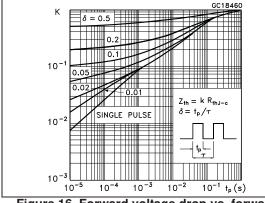
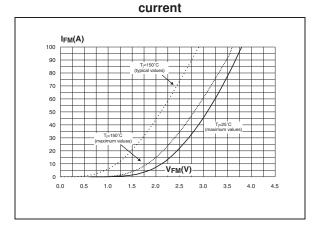
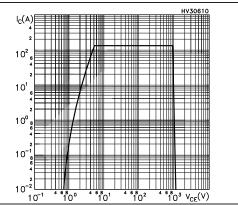


Figure 16. Forward voltage drop vs. forward

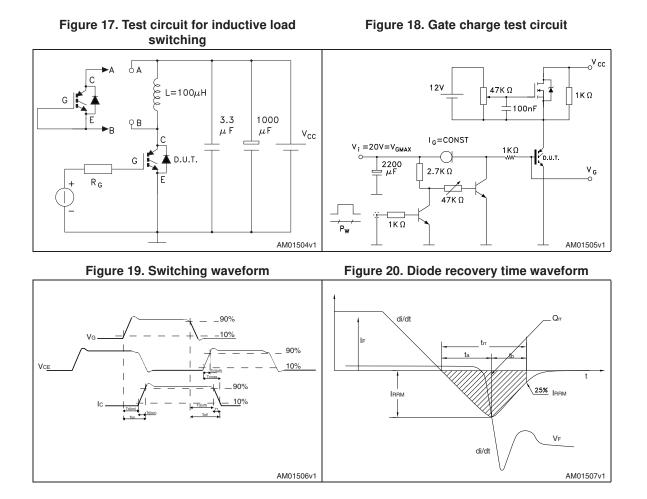








3 Test circuits





4 Package mechanical data

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Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.90		5.15
D	1.85		2.10
E	0.55		0.67
F	1.07		1.32
F1	1.90		2.38
F2	2.87		3.38
G		10.90 BSC	•
Н	15.77		16.02
L	20.82		21.07
L1	4.16		4.47
L2	5.49		5.74
L3	20.05		20.30
L4	3.68		3.93
L5	6.04		6.29
М	2.25		2.55
V		10°	
V1		3°	
V3		20°	
Dia.	3.55		3.66

Table 9. TO-247 long leads mechanical data



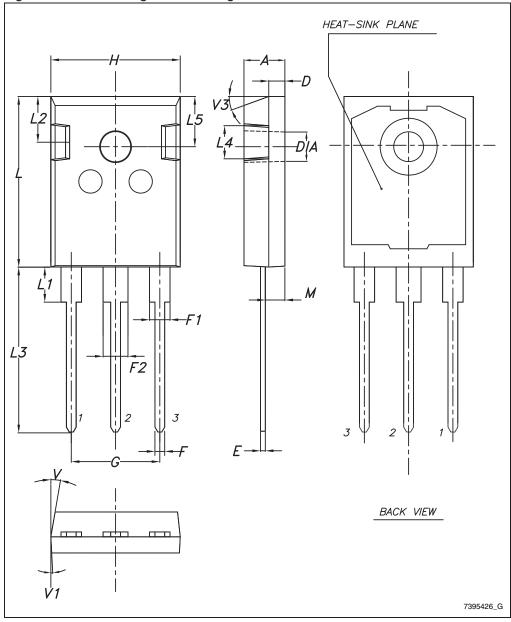


Figure 21. TO-247 long leads drawing



5 Revision history

Table 10. Document	revision	history
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Date	Revision	Changes
25-Jan-2008	1	First issue.
07-May-2009	2	Section 4: Package mechanical data has been updated.
12-Dec-2013	3	Updated <i>Section 4: Package mechanical data.</i> Minor text changes.



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